



Product Change Notification

Change Notification #: 115254 - 03

Change Title: Intel® Server Systems
R2308WTTYSR, R1208WT2GSR,
R1208WTTGSR, R1304WTTGSR,
R1304WT2GSR, R2208WTTYSR,
R2208WT2YSR, R2208WTTYC1R,
R2224WTTYSR, R2312WTTYSR,
S2600WTTR, S2600WT2R,
S2600WTTS1R
PCN 115254 – 03, Product Design,
Replacing Memory

**Reason for Revision: Update to
TA/PBA Numbers for MM#943785,
and PBA Number for MM#943786**

Date of Publication: July 14, 2017

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	Jan 23, 2017
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** Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.*

Description of Change to the Customer:

Reason for Revision: Update to TA/PBA Numbers for MM#943785, and PBA Number for MM#943786

Please see the Products Affected/Intel Ordering Codes table for updated TA#'s and PBA#'s. Customers can expect to receive the material changes with the TA and PBA#'s shown in the table.

Intel is replacing the current BMC DDR3 memory chip K4B1G1646G-BCH9 (G38649-001) (end of life) with new K4B1G1646I-BCK0 (J37656-001). Intel reports validation completed with passing results. The replacement component is identical in form, fit and function.

Current DDR3 (G38649-001)**New DDR3 (J37656-001)****Customer Impact of Change and Recommended Action:**

Intel does not expect any impact to customers from these changes, but encourages customers to understand the change and determine the impact on their applications.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Post Change TA	Pre Change PBA	Post Change PBA
R2308WTTYSR	943829	J11493-006	J11493-007	G92187-371	G92187-372
R1208WT2GSR	943894	J11465-004	J11465-005	H21573-371	H21573-372
R1208WTTGSR	943893	J11481-005	J11481-006	G92187-371	G92187-372
R1304WTTGSR	943891	J11482-004	J11482-005	G92187-371	G92187-372
R1304WT2GSR	943892	J11483-004	J11483-005	H21573-371	H21573-372
R2208WTTYSR	943826	J11484-006	J11484-007	G92187-371	G92187-372
R2208WT2YSR	943827	J11485-005	J11485-006	H21573-371	H21573-372
R2208WTTYC1R	943828	J11487-005	J11487-006	G92187-371	G92187-372
R2224WTTYSR	943831	J11492-006	J11492-007	G92187-371	G92187-372
R2312WTTYSR	951229	J11495-007	J11495-008	G92187-371	G92187-372
S2600WTTR	943785	H79751-004	H79751-005	G92187-371	G92187-372
S2600WT2R	943786	H79749-003	H79749-004	H21573-371	H21573-372
S2600WTT1R	949339	J18114-001	J18114-002	G92187-366	G92187-372

PCN Revision History:

Date of Revision:	Revision Number:	Reason:
January 13, 2017	00	Originally Published PCN
February 9, 2017	01	Adding additional Product Codes
March 3, 2017	02	Update TA Numbers
July 14, 2017	03	Update to TA/PBA Numbers for MM#943785, and PBA Number for MM#943786



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

Asia Pacific/PRC Contact: apacgccb@intel.com

Europe Email: eccb@intel.com

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